TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (U-MOS IV)

## **TPCP8002**

# Notebook PC Applications Portable Equipment Applications

- Small footprint due to a small and thin package
- Low drain-source ON-resistance:
   RDS (ON) = 7 mΩ (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 36 \text{ S (typ.)}$
- Low leakage current: I<sub>DSS</sub> = 10 μA (V<sub>DS</sub> = 20 V)
- Enhancement mode:  $V_{th} = 0.5 \text{ to } 1.2 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 0.2 \text{ mA})$

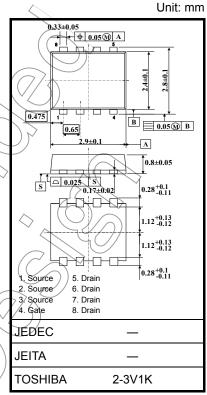
#### Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-source voltage			$V_{DSS}$	20	> V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )			$V_{DGR}$	20	V
Gate-source voltage			V <sub>GSS</sub>	±12	V
Drain current	DC	(Note 1)	I <sub>D</sub>	9.1	A
	Pulse	(Note 1)	IDP	36.4	\\A
Drain power dissipation (t = 5 s) (Note 2a)		PD	1.68		
Drain power dissipation (t = 5 s) (Note 2b)			PD	0.84	w
Single pulse avalanche energy (Note 3)			EAS	21.5	→ mJ
Avalanche current			JAR (	9.1	Α
Repetitive avalanche energy (Note 4)		EAR	0.168	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 150	°C	

Note: For Notes 1 to 5, refer to the next page.

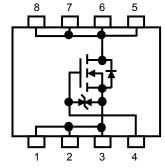
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

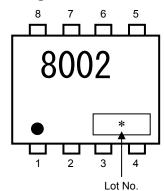


Weight: 0.017 g (typ.)

#### **Circuit Configuration**



#### Marking (Note 5)



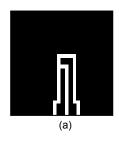
#### **Thermal Characteristics**

Characteristic	Symbol	Max	Unit	
Thermal resistance, channel to ambient (t = 5 s) (Note 2a)	R <sub>th (ch-a)</sub>	74.4	°C/W	
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R <sub>th (ch-a)</sub>	148.8	°C/W	

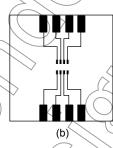
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)



FR-4  $25.4 \times 25.4 \times 0.8t$  Unit: (mm)



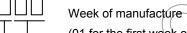
FR-4 25.4 × 25.4 × 0.8t Unit: (mm)

Note 3:  $V_{DD} = 16 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 0.2 mH,  $R_{Q} = 25 \Omega$ ,  $I_{AR} = 9.1 \text{ A}$ 

Note 4: Repetitive rating: pulse width limited by maximum channel temperature.

Note 5: • on the lower left of the marking indicates Pin 1.

\* Weekly code (3 digits):



(01 for the first week of the year, continuing up to 52 or 53)

Year of manufacture

(The last digit of the year)

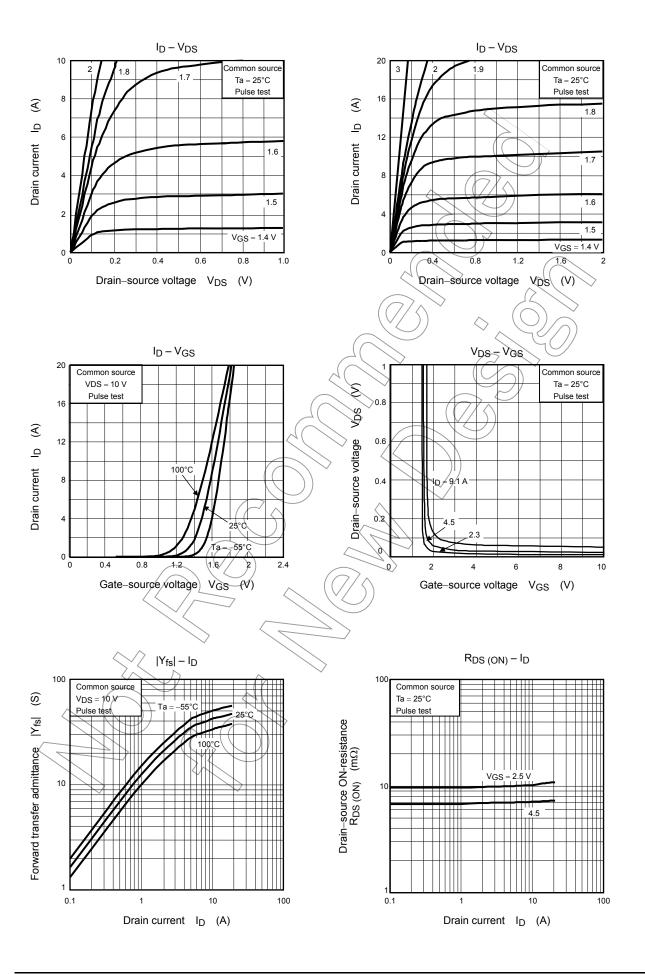


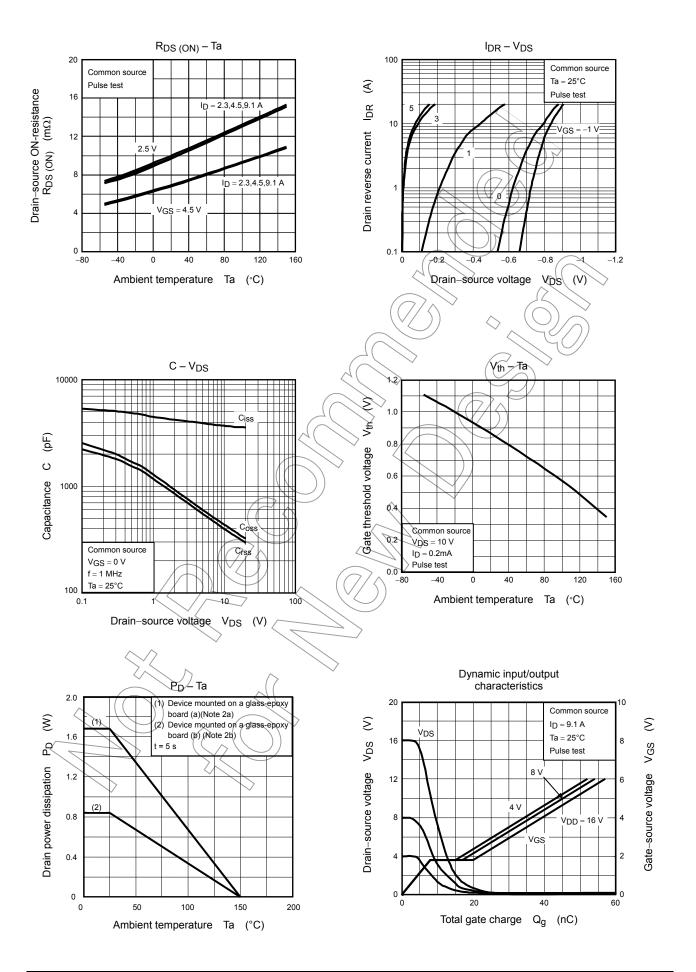
### Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I <sub>GSS</sub>	V <sub>GS</sub> = ±10 V, V <sub>DS</sub> = 0 V	/_	_	±10	μΑ
Drain cut-off current		I <sub>DSS</sub>	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V		/	10	μA
Drain-source breakdown voltage		V <sub>(BR) DSS</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = 0 V	20	))_		٧
		V <sub>(BR) DSX</sub>	I <sub>D</sub> = 10 mA, V <sub>GS</sub> = -12 V	/8		_	
Gate threshold voltage		V <sub>th</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 0.2 mA	0.5	_	1.2	V
Drain-source ON-resistance		R <sub>DS (ON)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 4.5 A	_	10	13.7	mΩ
			V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 4.5 A	_	7	10	
Forward transfer admittance		Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 4.5 A	18	36	/_	S
Input capacitance		C <sub>iss</sub>		- (	3700	_	
Reverse transfer capacitance		C <sub>rss</sub>	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	+(	400	<u> </u>	pF
Output capacitance		Coss		1	(450)	) —	
Switching time	Rise time	t <sub>r</sub>	V6S ID = 4.5 A	7/6	> 14	_	
	Turn-on time	t <sub>on</sub>	TuoVo C C C C C C C C C C C C C C C C C C		24	_	no
	Fall time	t <sub>f</sub>	ADD ≈ 10 A	<i></i>	30		ns
	Turn-off time	toff	Duty ≤1 %, t <sub>W</sub> = 10 μs	_	110	_	
Total gate charge (gate-source plus gate-drain)		Qg g		_	48	_	
Gate-source charge 1		Q <sub>gs1</sub>	$V_{DD} \approx 16 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 9.1 \text{ A}$	_	8	_	nC
Gate-drain ("Miller") charge		)) Q <sub>gd</sub>			12	_	

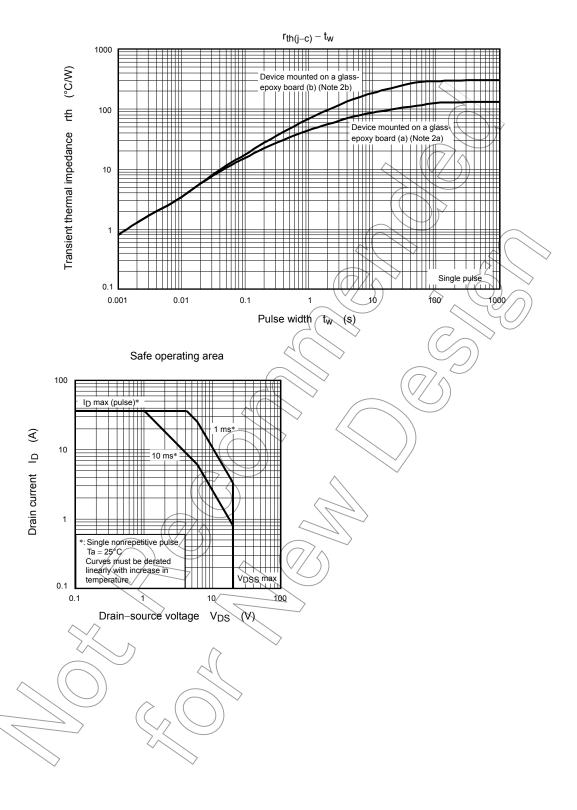
# Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note 1)	IDRP	_	_	_	36.4	Α
Forward voltage (diode)	V <sub>DSF</sub>	I <sub>DR</sub> = 9.1 A, V <sub>GS</sub> = 0 V		_	-1.2	V





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